UNISONIC TECHNOLOGIES CO., LTD

1NM50-S Power MOSFET

1.0A, 500V N-CHANNEL SUPER-JUNCTION MOSFET

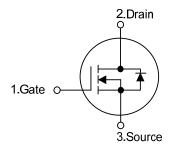
DESCRIPTION

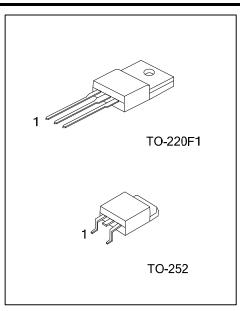
The **UTC 1NM50-S** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(ON)}$ < 5.00 @ V_{GS} = 10V, I_{D} =0.5A
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

■ SYMBOL

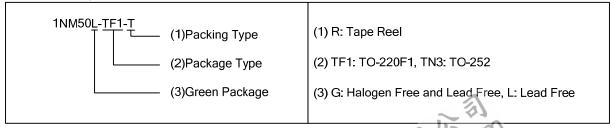




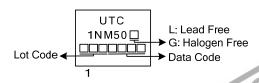
ORDERING INFORMATION

Ordering Number		Dealtage	Pin Assignment			Dealing	
Lead Free	Halogen Free	Package	1	2	3	Packing	
1NM50L-TF1-T	1NM50G-TF1-T	TO-220F1	G	D	S	Tube	
1NM50L-TN3-R	1NM50G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



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■ **ABSOLUTE MAXIMUM RATINGS** (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	500	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous	I _D	1.0	Α	
	Pulsed (Note 2)	I_{DM}	4.0	Α	
Avalanche Current (Note 2)		I_{AR}	0.9	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	58	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	5.3	V/ns	
Power Dissipation	TO-220F1	ם	20	W	
	TO-252	P_D	40	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=144mH, I_{AS} =0.9A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 1.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F1	0	62.5	°C/W
	TO-252	θ_{JA}	110	°C/W
Junction to Case	TO-220F1	0	6.25	°C/W
	TO-252	$\theta_{ m JC}$	3.125	°C/W



ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	500			V	
Drain-Source Leakage Current		I_{DSS}	$V_{DS} = 500V, V_{GS} = 0V$			10	μA	
Gate-Source Leakage Current	Forward	- I _{GSS}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA	
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA	
ON CHARACTERISTICS								
Gate Threold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10V, I_D = 0.5A$			5.0	Ω	
DYNAMIC CHARACTERISTICS	_							
Input Capacitance		C _{ISS}			64		pF	
Output Capacitance		Coss	V_{GS} =0V, V_{DS} =25V, f =1MHz		45		pF	
Reverse Transfer Capacitance		C_{RSS}			8		pF	
SWITCHING CHARACTERISTIC	S	-				-		
Total Gate Charge (Note 1)		Q_G	V _{DS} =50V, V _{GS} =10V, I _D =1.3A		12		nC	
Gate to Source Charge		Q_GS	I_{G} =100µA (Note 1, 2)		1.8		nC	
Gate to Drain Charge		Q_GD	IG-100μA (Note 1, 2)		3.6		nC	
Turn-ON Delay Time (Note 1)		t _{D (ON)}			44		ns	
Rise Time		t_R	V_{DD} =30V, V_{GS} =10V, I_{D} =0.5A, R_{G} =25 Ω (Note 1, 2)		43		ns	
Turn-OFF Delay Time		$t_{D(OFF)}$			53		ns	
Fall-Time		t_{F}			35		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		Is				1.0	Α	
Maximum Body-Diode Pulsed Current		I _{SM}				4.0	Α	
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =1.0A, V _{GS} =0V			1.4	V	
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =1.0A, V _{GS} =0V, dI _F /dt=100A/µs		150		nS	
Body Diode Reverse Recovery Charge		Qrr			460		nC	

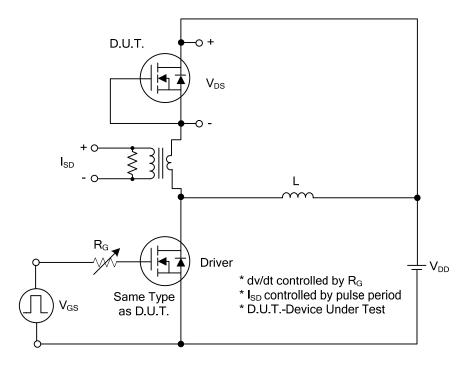
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%.



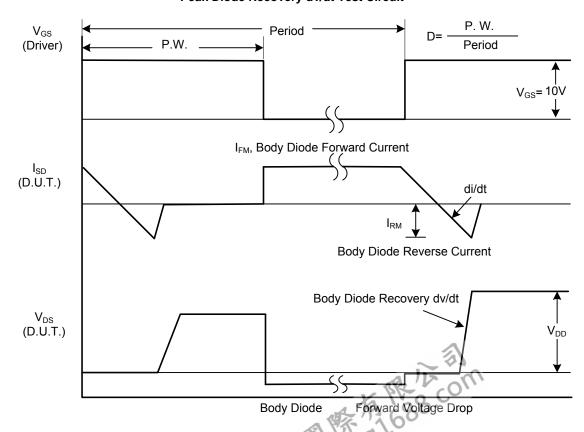
^{2.} Essentially independent of operating temperature.

1NM50-S Power MOSFET

■ TEST CIRCUITS AND WAVEFORMS



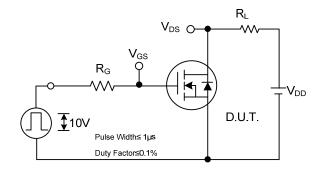
Peak Diode Recovery dv/dt Test Circuit

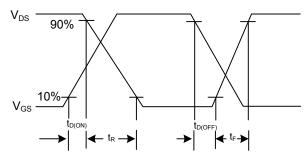


Peak Diode Recovery dv/dt Waveforms

1NM50-S **Power MOSFET**

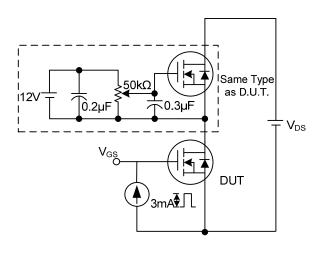
TEST CIRCUITS AND WAVEFORMS (Cont.)

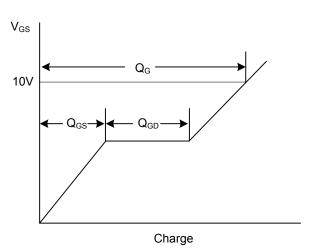




Switching Test Circuit

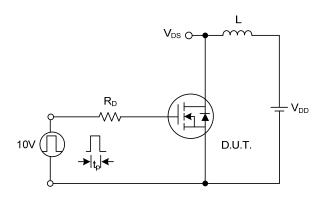
Switching Waveforms

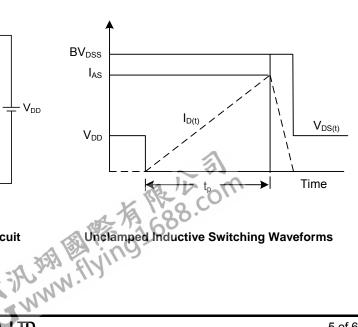




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

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